

PATENT ASSIGNMENT COVER SHEET

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 Stylesheet Version v1.2

EPAS ID: PAT2752713

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
VICTOR MOROZ	11/29/2005
DIPANKAR PRAMANIK	11/29/2005
RECEIVING PARTY DATA	
Name:	SYNOPSYS, INC.
Street Address:	700 E. MIDDLEFIELD ROAD
City:	MOUNTAIN VIEW,
State/Country:	CALIFORNIA
Postal Code:	94043-4033
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14025600
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Address Line 1:	637 MAIN ST.
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ATTORNEY DOCKET NUMBER:	SYNP 0693-10
NAME OF SUBMITTER:	WARREN S. WOLFELD
Signature:	/Warren S. Wolfeld/
Date:	03/04/2014
Total Attachments: 2 source=00414942#page1.tif source=00414942#page2.tif	

**JOINT TO CORPORATE
ASSIGNMENT**

WHEREAS, the undersigned,
hereinafter termed "Inventors", have invented certain new and useful improvements in

ANALYSIS OF STRESS IMPACT ON TRANSISTOR PERFORMANCE

and are filing such an application herewith, and have executed an oath or declaration of inventorship for such application on:

(1) the 29 day of November, 2005;

(2) the 29 day of November, 2005;

(hereinafter termed "application"); and

WHEREAS Synopsys, Inc., a corporation of Delaware, having a place of business at 700 E. Middlefield Road, Mountain View, California 94043-4033 (hereinafter termed "Assignee"), is desirous of acquiring the entire right, title and interest in and to said application and the invention disclosed therein, and in and to all embodiments of the invention, heretofore conceived, made or discovered jointly or severally by said Inventors (all collectively hereinafter termed "said invention"), and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter termed "patents") thereon granted in the United States and foreign countries.

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Inventors to have been received in full from said Assignee:

1. Said Inventors do hereby sell, assign, transfer and convey unto said Assignee the entire right, title and interest (a) in and to said application and said invention; (b) in and to all rights to apply for foreign patents on said invention pursuant to the International Convention for the Protection of Industrial Property or otherwise; (c) in and to any and all applications filed and any and all patents granted on said invention in the United States or any foreign country, including each and every application filed and each and every patent granted on any application which is a divisional, substitution, continuation, or continuation-in-part of any of said applications; and (d) in and to each and every reissue or extensions of any of said patents.

2. Said Inventors hereby jointly and severally covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest herein conveyed in the United States and foreign countries. Such cooperation by said Inventors shall include prompt production of pertinent facts and documents, giving of testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting substitute, divisional, continuing or additional applications covering said invention; (d) for filing and prosecuting applications for

Application No.

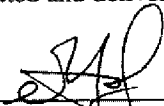
Atty. Docket: SNYP 0693-1

reissuance of any said patents; (e) for interference or other priority proceedings involving said invention; and (f) for legal proceedings involving said invention and any applications therefor and any patents granted thereon, including without limitation reissues and reexaminations, opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Inventors in providing such cooperation shall be paid for by said Assignee.

3. The terms and covenants of this assignment shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Inventors, their respective heirs, legal representatives and assigns.

4. Said Inventors hereby jointly and severally warrant and represent that they have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, said Inventors have executed and delivered this instrument to said Assignee as of the dates written below.

Dated: November 29, 2005 Signed: 
Victor Moroz

Dated: November 29, 2005 Signed: 
Dipankar Pramanik